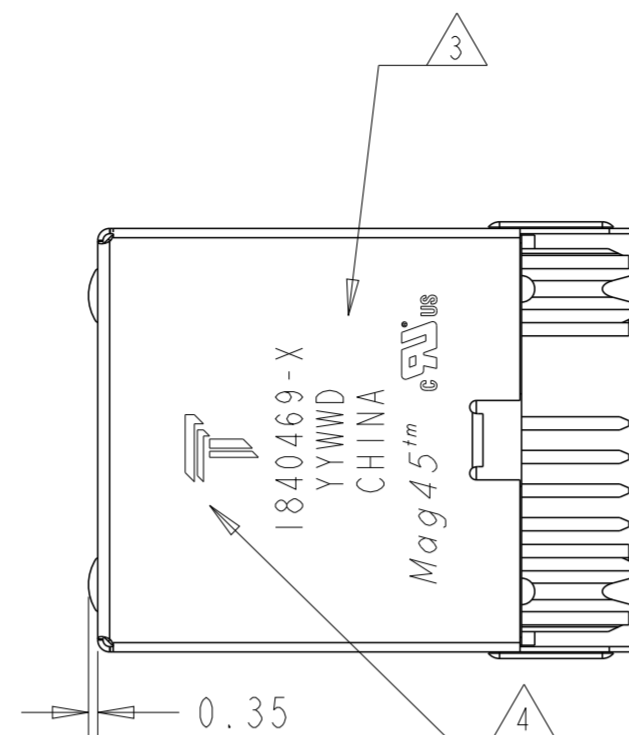
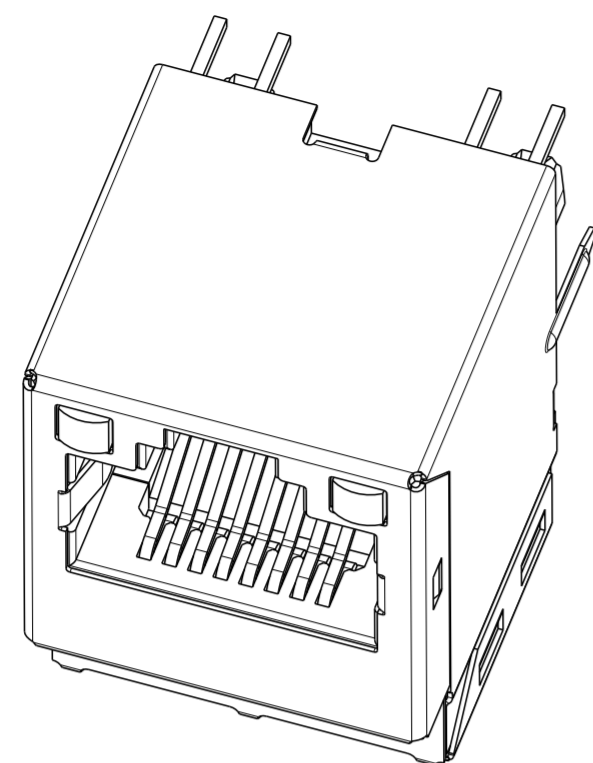
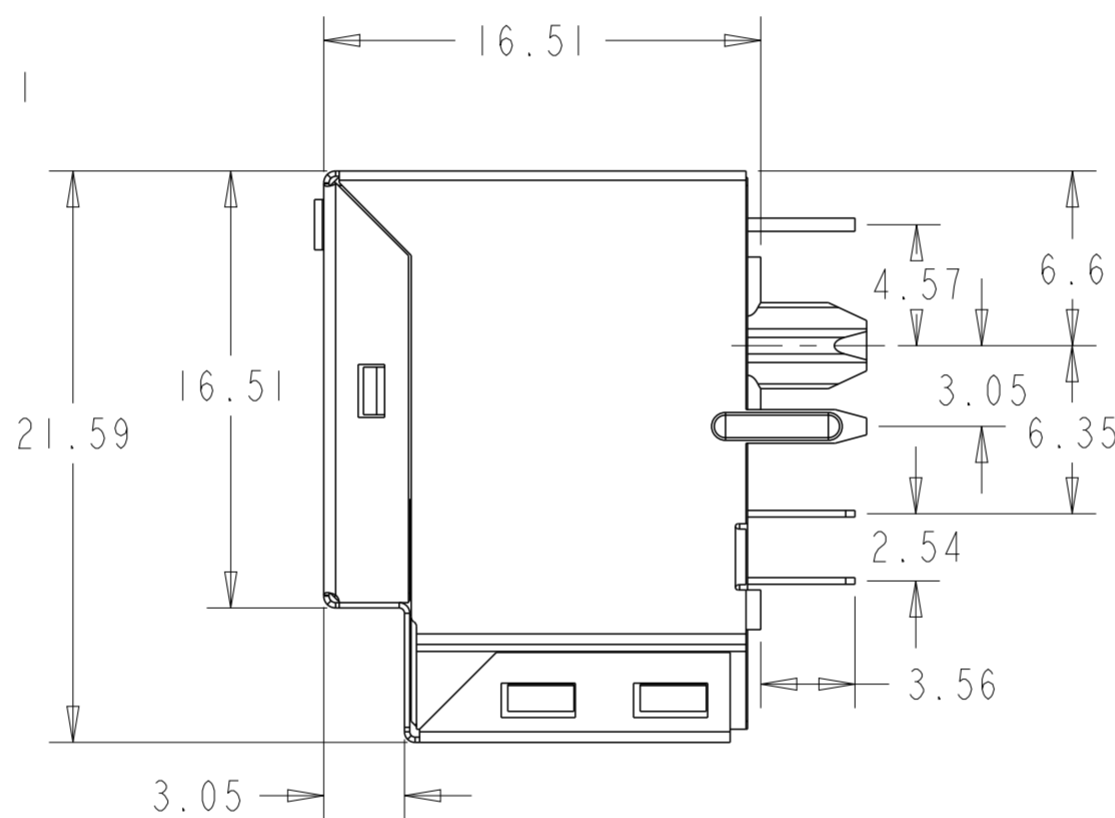
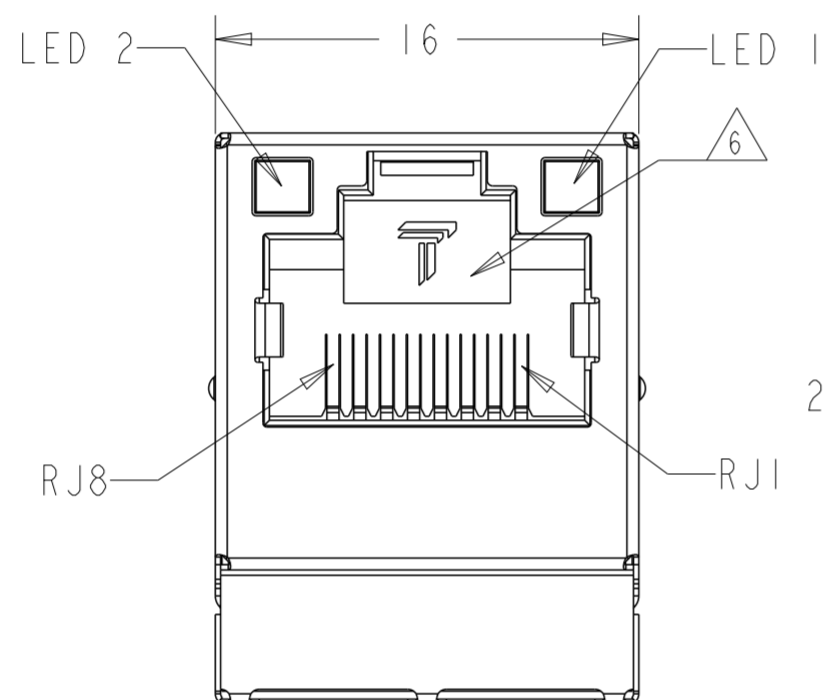
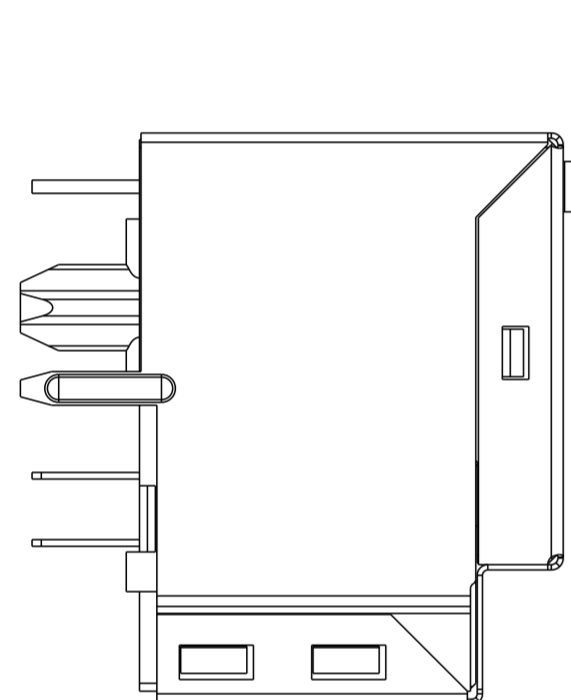


REVISIONS				
P	LTR	DESCRIPTION	DATE	DWN APVD
C		LOGO CHANGE	07APR2013	PP KZ



1 MATERIALS:
 PLASTIC HOUSING: BLACK, THERMOPLASTIC FLAMMABILITY RATING UL 94V-0
 SHIELD: BRASS, PREPLATED WITH 0.76um MIN SEMI-BRIGHT NICKEL, POST DIPPED WITH 2.54um MIN SAC SOLDER ON SOLDER TAILS,
 CONTACTS: PHOSPHOR BRONZE, 1.27um MIN OVERALL NICKEL UNDERPLATE WITH SELECT 1.27um MIN GOLD AT MATING INTERFACE AND 2.54um MIN MATTE TIN ON SOLDER TAILS.
 ALL PC BOARDS: HIGH TEMP PCB, TG>170°C.
 LED: DIFFUSED EPOXY LENS, 0.50mm SQUARE CARBON STEEL WIREFRAME LEADS PREPLATED WITH 2.03um MIN SILVER OVER 1.02um MIN NICKEL OVER 1.02um MIN COPPER UNDERPLATE POST PLATED WITH 2.54um MIN TIN

2 MAGNETICS
 APPLICATION: 10/100 BASE-T, EXTENDED TEMPERATURE, PoE
 IMPEDANCE: 100 OHMS
 TURNS RATIO (CHIP:CABLE): TX = 1:1, RX = 1:1
 OPEN CIRCUIT INDUCTANCE (OCL): 350uH MIN @100kHz, 0.1VRMS, 8mADC BIAS FROM -40°C TO +85°C, TX AND RX
 POE CURRENT: 350mADC MAX
 PERFORMANCE @ 25°C:
 INSERTION LOSS (IL): 1.1dB MAX FROM 0.5MHz TO 100MHz
 RETURN LOSS (RL): 18dB MIN FROM 0.5MHz TO 30MHz
 18-20LOG(f/30)dB MIN FROM 30.1MHz TO 60MHz
 12dB MIN FROM 60.1MHz TO 80MHz
 CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 40MHz
 33-20LOG(f/50)dB MIN FROM 40.1MHz TO 100MHz
 COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHz TO 100MHz
 ISOLATION VOLTAGE: COMPLIES WITH IEEE802.3af 2003, PARA 33.4.1, ITEM a.



3 PART NUMBER, DATE CODE AND COUNTRY OF ORIGIN LOCATED IN APPROXIMATE AREA SHOWN. DATE CODE: YY IS YEAR, WW IS WORK WEEK, D IS DAY OF WEEK WITH SUNDAY=1.

4 TRP CONNECTOR LOGO AND AGENCY APPROVAL LOGO, TO BE LOCATED IN APPROXIMATE AREA SHOWN.

5. OPERATING TEMP: FROM -40°C TO +85°C.

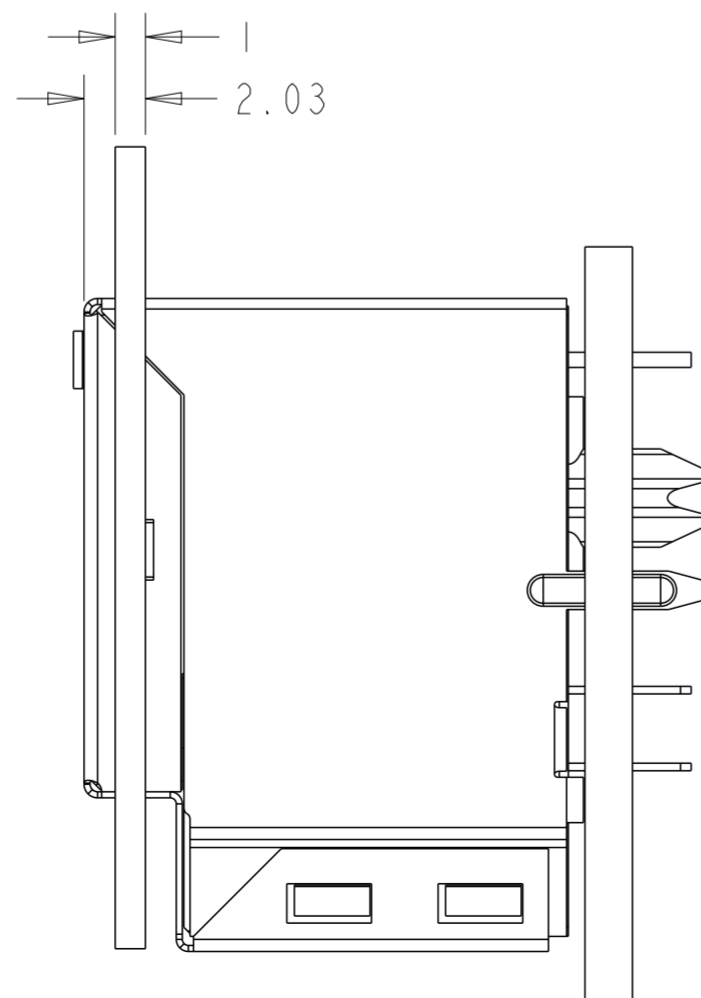
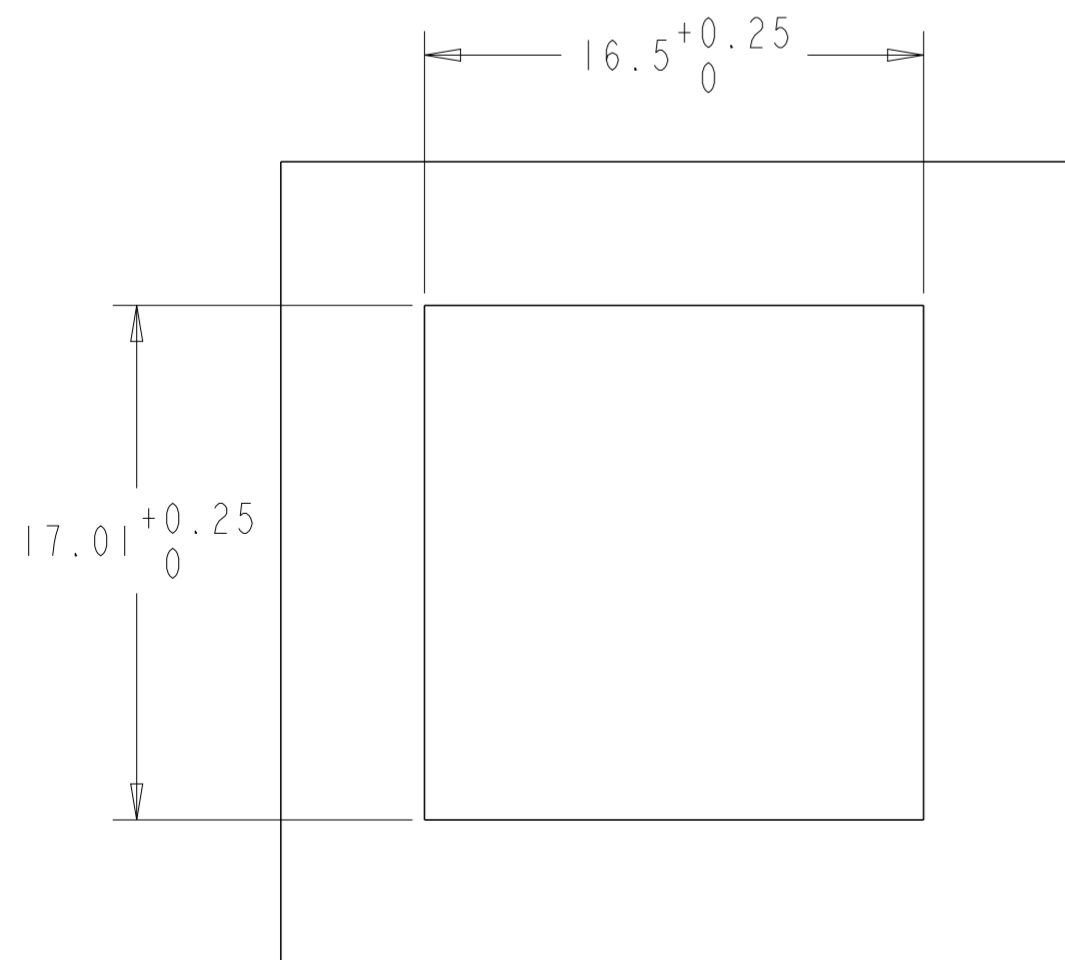
6 RJ45 CAVITY CONFORMS TO FCC RULES AND REGULATION PART 68 SUBPART F.

7 THE PARTS ARE RECOMMENDED FOR WAVE SOLDERING PROCESS, PEAK TEMPERATURE 260°C MAX. 10 SECONDS MAX.

8. LED IS DRIVEN WITH CONSTANT CURRENT AT APPROX 20mA.

DOMINANT WAVELENGTH(λ D)
 GREEN 568nm TYP.at IF=20mA
 YELLOW 588nm TYP.at IF=20mA

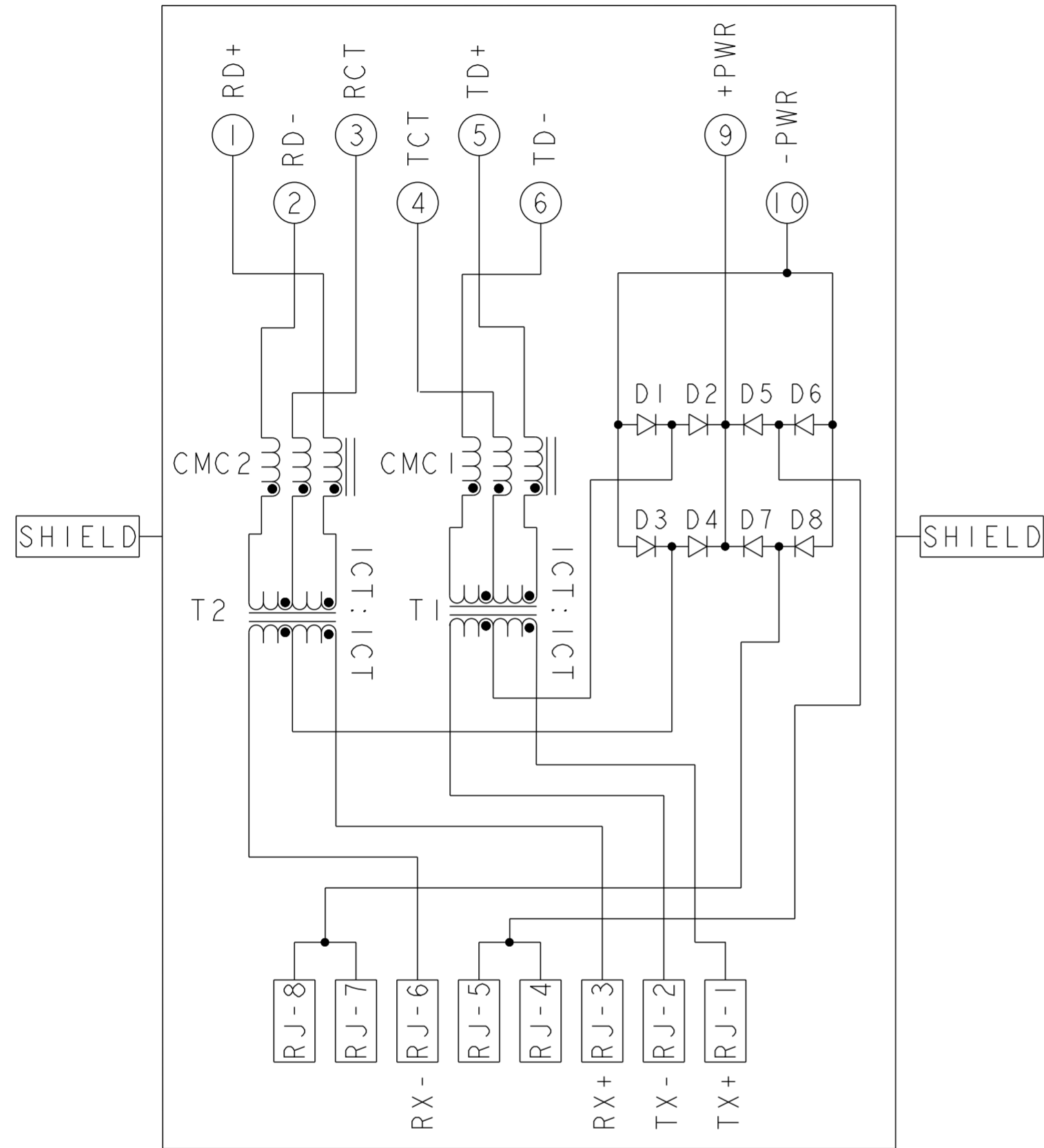
FORWARD VOLTAGE(VF):
 GREEN 2.2V TYP.at IF=20mA
 YELLOW 2.1V TYP.at IF=20mA



GRN/YEL	GRN/YEL	1840469-4
YELLOW	GREEN	1840469-3
GREEN	YELLOW	1840469-2
GREEN	GREEN	1840469-1
LED 1	LED 2	PART NUMBER

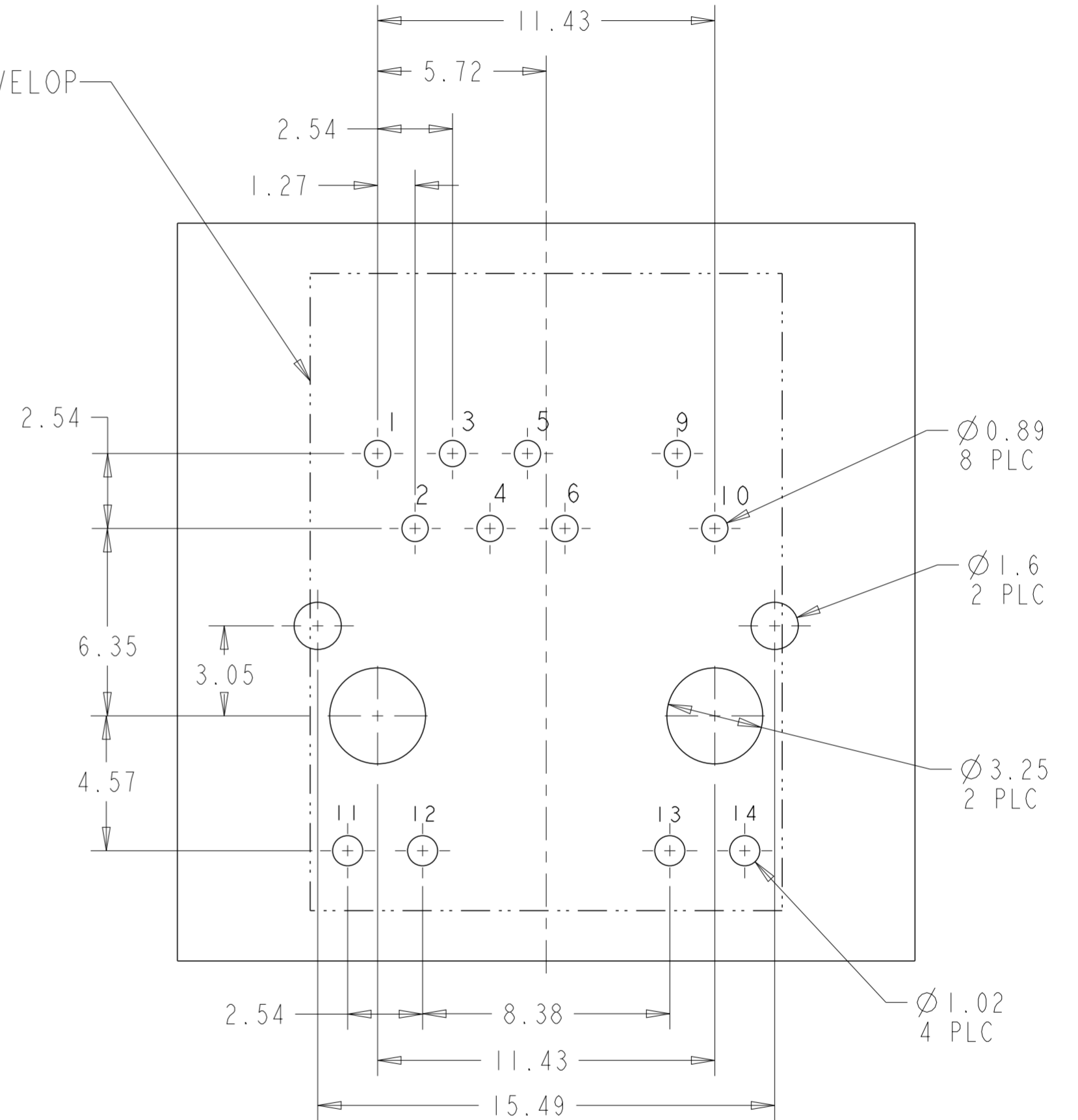
THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN WESLEY.YI 25DEC2008	 TRP connector Dongguan China	
DIMENSIONS: mm		CHK KELTH ZHU 25DEC2008		
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD TEDDY XIONG 25DEC2008	NAME IXI MAG45(TM) MODULAR JACK, VERTICAL, 7D52ET 10/100, BASE-T POE CIRCUIT, LED	
0 PLC ±0.25 1 PLC ±0.25 2 PLC ±0.25 3 PLC ±0.25 4 PLC ± ANGLES ± FINISH		PRODUCT SPEC	SIZE A2	
MATERIAL		APPLICATION SPEC	CAGE CODE 00779	DRAWING NO C-1840469
		WEIGHT	RESTRICTED TO	
		CUSTOMER DRAWING	SCALE 3:1	SHEET 1 OF 2
			REV C	

7D52ET 10/100 BASE-T POE CIRCUIT



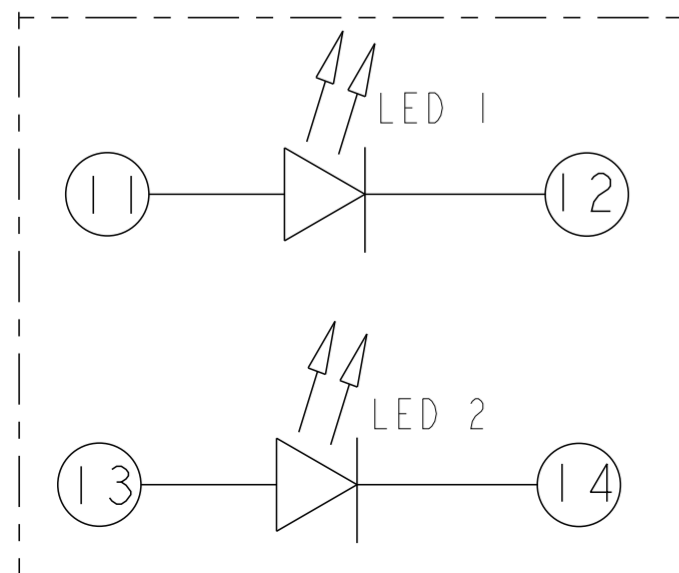
DI-D8 = Rectifier Diode
 Forward Voltage, $V_f = 1.2V$ Max @ $I_f = 0.5A$
 Forward Current, $I_f = 0.5A$ Max
 Reverse Voltage, $V_r = 80V$ Max

CONNECTOR ENVELOP

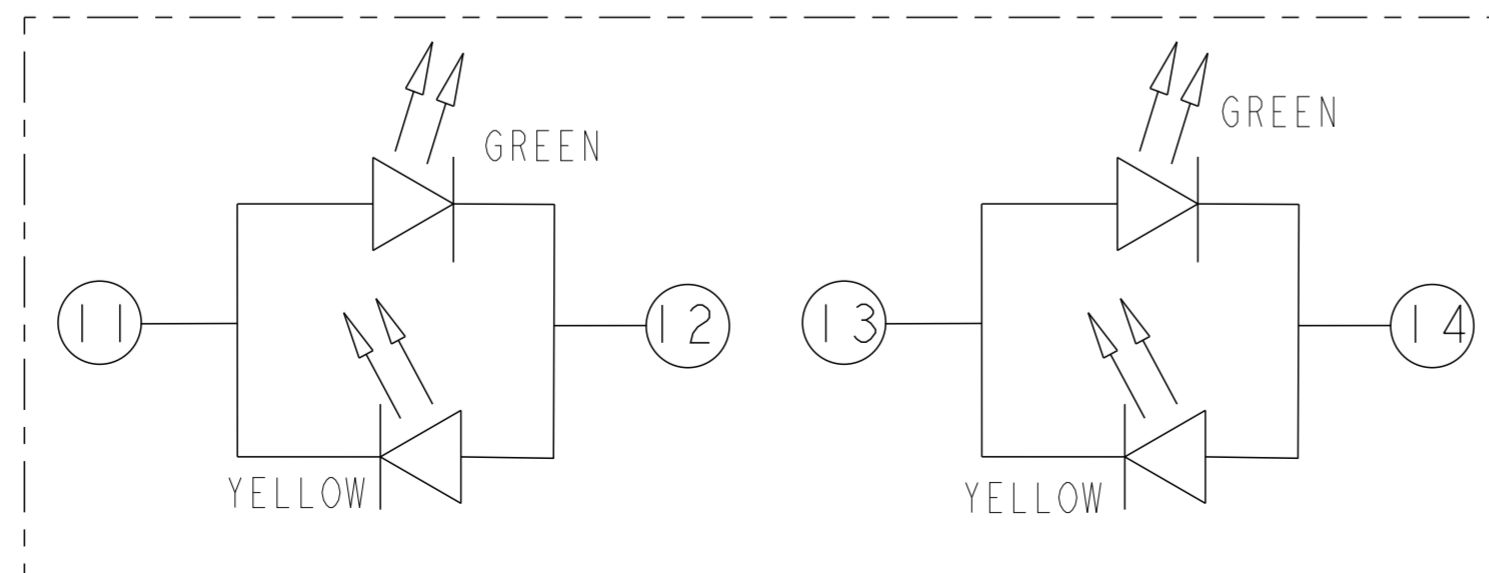


SUGGESTED PCB LAYOUT (TOL: ±0.05)
 (COMPONENT SIDE VIEW)

SINGLE COLOR LED



BI-COLOR LED



THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN: WESLEY.YI 25DEC2008	 TRP connector Dongguan China
DIMENSIONS: mm		CHK: KEITH.ZHU 25DEC2008	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: TEDDY.XIONG 25DEC2008	
0 PLC ±0.25 1 PLC ±0.25 2 PLC ±0.25 3 PLC ±0.25 4 PLC ± ANGLES ± FINISH ±		PRODUCT SPEC	
MATERIAL		APPLICATION SPEC	NAME: IXI MAG45(TM) MODULAR JACK, VERTICAL, 7D52ET 10/100, BASE-T POE CIRCUIT, LED
		WEIGHT	SIZE: A2 CAGE CODE: 00779 DRAWING NO: C-1840469 RESTRICTED TO
CUSTOMER DRAWING		SCALE: 3:1	SHEET 2 OF 2 REV C